

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Group Art Unit of parent application: 2823

Examiner of parent application: Thanh V Pham

In Re PATENT APPLICATION Of:

Applicants : kazuaki YOSHIKE )

Appln. No. : To Be Assigned )

Div of Ser. No : 10/300,782 filed November 21, 2002, which )  
is a division of 09/782,163 filed February )  
14, 2001 )

Filed : Herewith )

For : LEAD FRAME FOR RESIN SEALED )  
SEMICONDUCTOR DEVICE (amended) )

Attorney Ref.: F99ED0138-DIV-DIV )

**PRELIMINARY**  
**AMENDMENT**

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July 23, 2003

**BOX: Non-Fee Amendment**

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

Sir:

Preliminary to examination, please amend the application as follows:

## **TITLE AMENDMENT**

Please amend the title of the invention as follows,

~~MOLDING APPARATUS FOR USE IN MANUFACTURING OF RESIN  
SHIELDING SEMICONDUCTOR DEVICE, AND A LEAD FRAME FOR RESIN  
SEALED SEMICONDUCTOR THE DEVICE, AND A METHOD OF USING THE  
APPARATUS~~